TOSHIBA Photocoupler Photo Relay

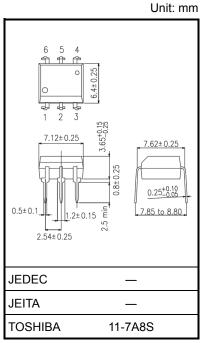
TLP797J

Telecommunication Measurement Instrumenation FA

The TOSHIBA TLP797J consists of an infrared emitting diode optically coupled to a photo-MOS FET in a six lead plastic DIP package (DIP6).

The TLP797J is a bi-directional switch can replace mechanical relays in many applications.

- 6 pin DIP (DIP6)
- 1-form-A
- Peak off-state voltage: 600 V (min)
- Trigger LED current: 5 mA (max)
- On-state current: 100 mA (max)
- On-state resistance: 35Ω (max)
- Isolation voltage: 5000 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349
- VDE- approved: EN 60747-5-5 (Note 1)



Weight: 0.4 g (typ.)

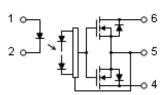
Note 1: When a VDE approved type is needed, please designate the **Option(D4)**.

• Construction mechanical rating

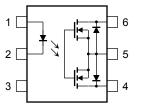
	7.62 mm pitch standard type	10.16 mm pitch TLPXXXF type
Creepage distance	7.0 mm (min)	8.0 mm (min)
Clearance	7.0 mm (min)	8.0 mm (min)
Insulation thickness	0.4 mm (min)	0.4 mm (min)

Note: When applying safety standard certification, use the standard part number, e.g., TLP797J.

Schematic



Pin Configurations (top view)



1: Anode

2: Cathode

3: N.C.

4: Drain D1

5: Source 6: Drain D2

Start of commercial production 2001-07

Absolute Maximum Ratings (Ta = 25°C)

	Character	istics	Symbol	Rating	Unit	
	Forward current		lF	50	mA	
	Forward current derating (Ta ≥ 25°C)			-0.5	mA/°C	
	Peak forward curren	t (100 μs pulse, 100 pps)	IFP	1	Α	
LED	Reverse voltage		V _R	5	V	
	Diode power dissipa	tion	P _D	50	mW	
	Diode power dissipa	tion derating (Ta ≥ 25°C)	ΔP _D /°C	-0.5	mW/°C	
	Junction temperature	Э	Tj	125	°C	
	Off-state output term	inal voltage	Voff	600	V	
		A connection		100		
	On-state current	B connection	Ion	100	mA	
		C connection		200		
	On-state current derating (Ta ≥ 25°C)	A connection		-1.0		
		B connection	Δlon/°C	-1.0	mA/°C	
Detector		C connection		-2.0		
Detector	Output power dissipation	A connection		430	mW	
		B connection	Po	330		
		C connection		504		
	Output power	A connection		-4.3		
	dissipation derating	B connection	ΔP ₀ /°C	-3.3	mW / °C	
	(Ta ≥ 25°C)	C connection		-5.04		
	Junction temperature	Junction temperature			°C	
Storage te	mperature range	T _{stg}	−55 to 125	°C		
Operating	Operating temperature range			-40 to 85	°C	
Lead solde	ering temperature (10	s)	T _{sol}	260	°C	
Isolation v	oltage (AC, 60 s, R.H.	≤ 60 %) (Note 1)	BVs	5000	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

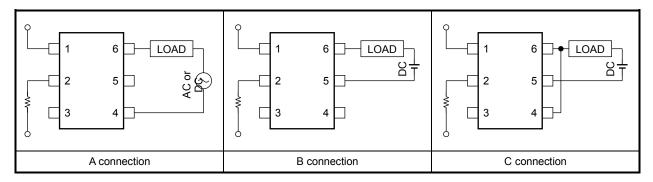
Note 1: Device considered a two-terminal device: Pins 1, 2 and 3 shorted together, and pins 4, 5 and 6 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V _{DD}	_	_	480	V
Forward current	lF	7.5	15	25	mA
On-state current	Ion	_	_	100	mA
Operating temperature	T _{opr}	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Circuit Connections



Individual Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	IF = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	IR	V _R = 5 V	1	-	10	μА
	Capacitance	Ст	V = 0 V, f = 1 MHz	_	30	_	pF
Detector	Off-state current	loff	V _{OFF} = 600 V	_	_	1	μА
Detector	Capacitance	Coff	V = 0 V, f = 1 MHz		120	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteris	stics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		I _{FT}	I _{ON} = 100 mA	_	1.6	5	mA
Close LED current		IFC	I _{OFF} = 100 μA	0.1	_	_	mA
	A connection		$I_{ON} = 100 \text{ mA}, I_F = 10 \text{ mA}, t < 1 \text{ s}$	– 25	25	35	
On-state resistance	A connection	Pou	ION = 100 mA, IF = 10 mA	_	30	45	
	I _{ON} = 100 mA, I _F = 10 mA	_	23	35	Ω		
	C connection		I _{ON} = 200 mA, I _F = 10 mA	_	12	_	

Isolation Characteristics (Ta = 25°C)

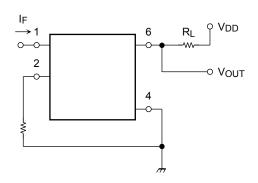
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V _S = 500 V, R.H. ≤ 60 %	5 × 10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVS	AC, 60 s	5000	_	_	Vrms

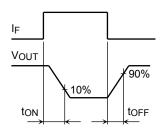


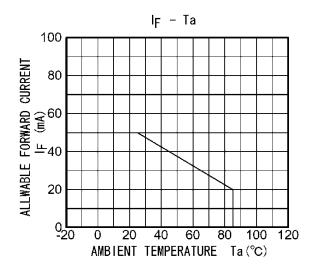
Switching Characteristics (Ta = 25°C)

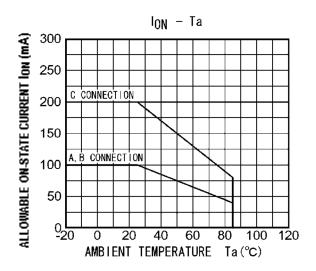
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	toN	$R_L = 200 \Omega$ (Note)	_	0.2	1.5	ms
Turn-off time	toff	$V_{DD} = 20 \text{ V, I}_{F} = 10 \text{ mA}$	_	0.2	1	ms

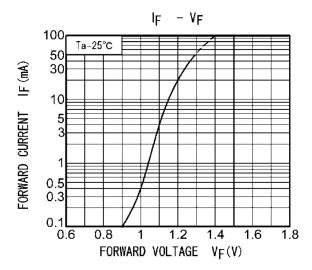
Note: Switching time test circuit

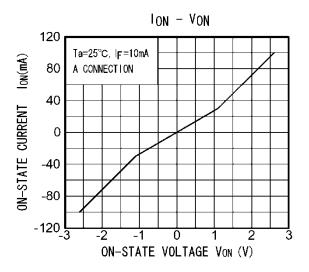


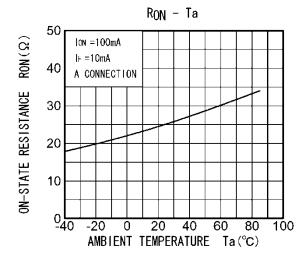


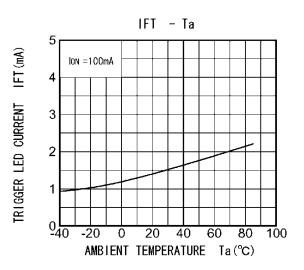




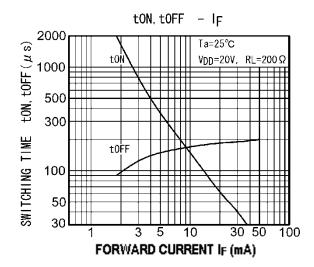


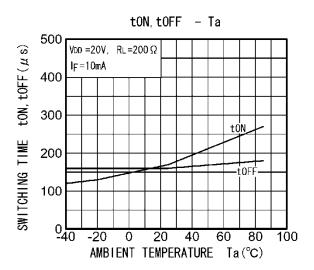






NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.





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